

MITSUBISHI IGBT MODULES
CM200DY-24NF

HIGH POWER SWITCHING USE

CM200DY-24NF



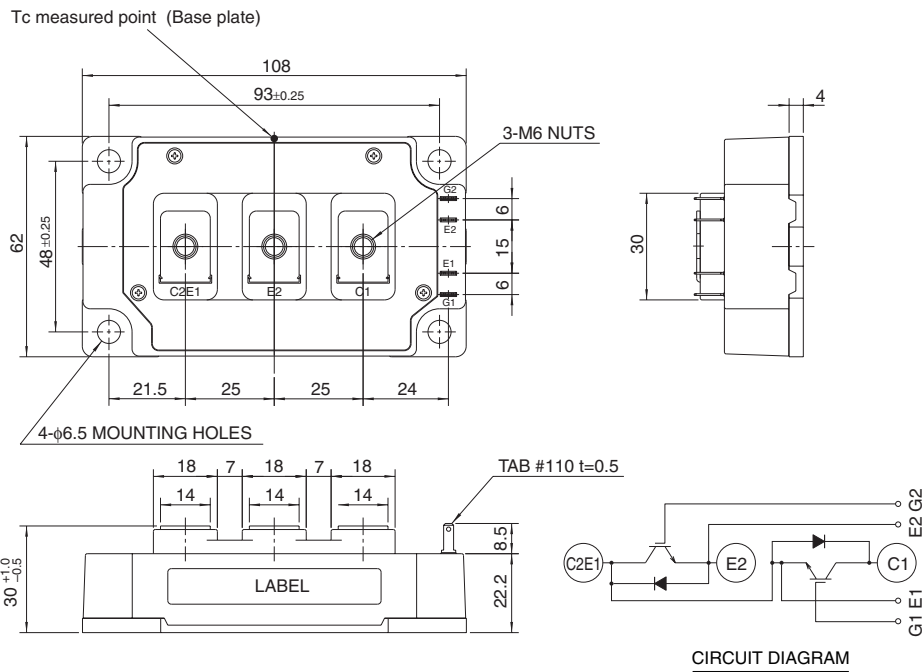
- IC 200A
- VCES 1200V
- Insulated Type
- 2-elements in a pack

APPLICATION

General purpose inverters & Servo controls, etc

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



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MAXIMUM RATINGS (T_j = 25°C, unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V _{CEs}	Collector-emitter voltage	G-E Short	1200	V
V _{GES}	Gate-emitter voltage	C-E Short	±20	V
I _C	Collector current	DC, T _c ' = 112°C ^{*3}	200	A
I _{CM}		Pulse (Note 2)	400	A
I _E (Note 1)	Emitter current		200	A
I _{EM} (Note 1)		Pulse (Note 2)	400	A
P _C (Note 3)	Maximum collector dissipation	T _c = 25°C	1130	W
T _j	Junction temperature		-40 ~ +150	°C
T _{stg}	Storage temperature		-40 ~ +125	°C
V _{iso}	Isolation voltage	Terminals to base plate, f = 60Hz, AC 1 minute	2500	V _{rms}
—	Torque strength	Main terminals M6 screw	3.5 ~ 4.5	N • m
—		Mounting M6 screw	3.5 ~ 4.5	N • m
—	Weight	Typical value	400	g

ELECTRICAL CHARACTERISTICS (T_j = 25°C, unless otherwise specified)

Symbol	Parameter	Test conditions	Limits			Unit							
			Min.	Typ.	Max.								
I _{CEs}	Collector cutoff current	V _{CE} = V _{CEs} , V _{GE} = 0V	—	—	1	mA							
V _{GE(th)}	Gate-emitter threshold voltage	I _C = 20mA, V _{CE} = 10V	6	7	8	V							
I _{GES}	Gate leakage current	±V _{GE} = V _{GES} , V _{CE} = 0V	—	—	0.5	μA							
V _{CE(sat)}	Collector-emitter saturation voltage	I _C = 200A, V _{GE} = 15V	<table border="1"> <tr> <td>T_j = 25°C</td> <td>—</td> <td>1.8</td> <td>2.5</td> </tr> <tr> <td>T_j = 125°C</td> <td>—</td> <td>2.0</td> <td>—</td> </tr> </table>		T _j = 25°C	—	1.8	2.5	T _j = 125°C	—	2.0	—	V
T _j = 25°C	—	1.8	2.5										
T _j = 125°C	—	2.0	—										
C _{ies}	Input capacitance	V _{CE} = 10V V _{GE} = 0V	—	—	47	nF							
C _{oes}	Output capacitance		—	—	4	nF							
C _{res}	Reverse transfer capacitance		—	—	0.9	nF							
Q _G	Total gate charge	V _{CC} = 600V, I _C = 200A, V _{GE} = 15V	—	1350	—	nC							
t _{d(on)}	Turn-on delay time	V _{CC} = 600V, I _C = 200A V _{GE} = ±15V R _G = 1.6Ω, Inductive load I _E = 200A	—	—	500	ns							
t _r	Turn-on rise time		—	—	150	ns							
t _{d(off)}	Turn-off delay time		—	—	600	ns							
t _f	Turn-off fall time		—	—	350	ns							
t _{rr} (Note 1)	Reverse recovery time		—	—	250	ns							
Q _{rr} (Note 1)	Reverse recovery charge		—	7.5	—	μC							
V _{EC} (Note 1)	Emitter-collector voltage	I _E = 200A, V _{GE} = 0V	—	—	3.2	V							
R _{th(j-c)Q}	Thermal resistance ^{*1}	IGBT part (1/2 module)	—	—	0.11	K/W							
R _{th(j-c)R}		FWDi part (1/2 module)	—	—	0.19	K/W							
R _{th(c-f)}	Contact thermal resistance	Case to heat sink, Thermal compound Applied ^{*2} (1/2 module)	—	0.04	—	K/W							
R _{th(j-c')Q}	Thermal resistance	Case temperature measured point is just under the chips	—	—	0.066 ^{*3}	K/W							
R _G	External gate resistance		1.6	—	16	Ω							

*1 : Case temperature (T_c) measured point is shown in page OUTLINE DRAWING.

*2 : Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m • K)].

*3 : Case temperature (T_c) measured point is just under the chips.

If you use this value, R_{th(f-a)} should be measured just under the chips.

Note 1. I_E, V_{EC}, t_{rr} & Q_{rr} represent characteristics of the anti-parallel, emitter-collector free-wheel diode (FWDi).

2. Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed T_{jmax} rating.

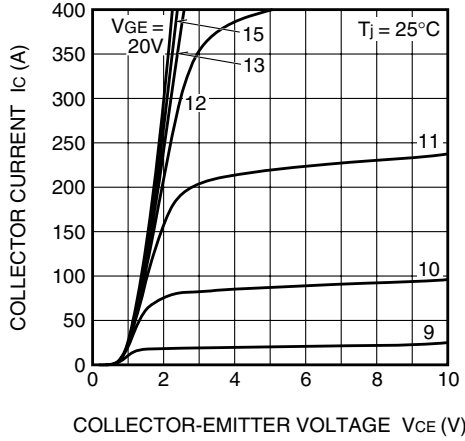
3. Junction temperature (T_j) should not increase beyond 150°C.

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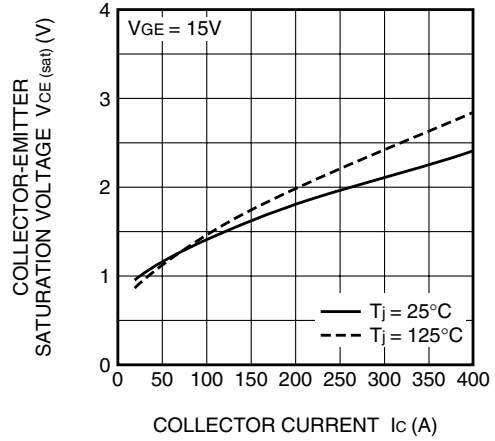
HIGH POWER SWITCHING USE

PERFORMANCE CURVES

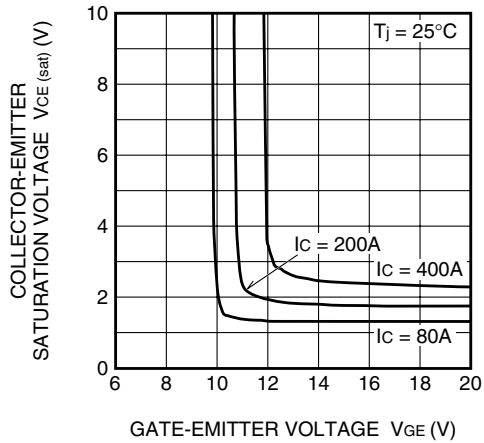
OUTPUT CHARACTERISTICS (TYPICAL)



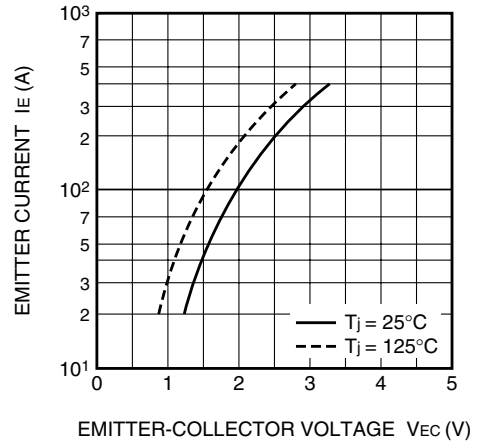
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



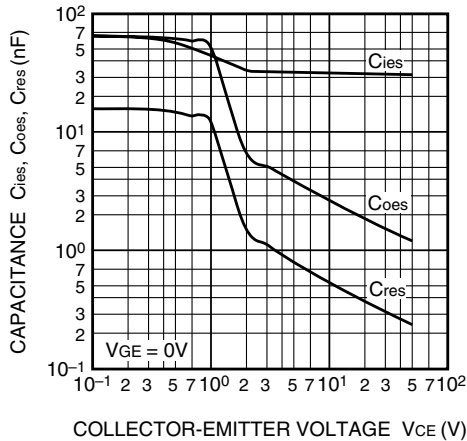
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



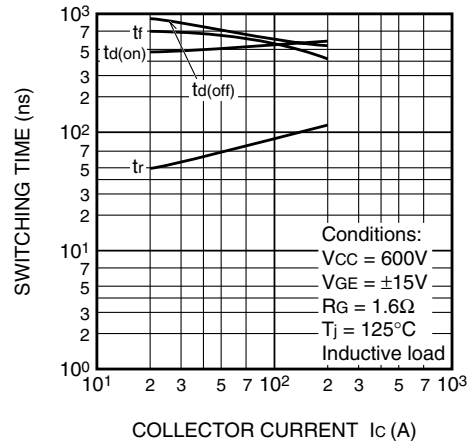
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



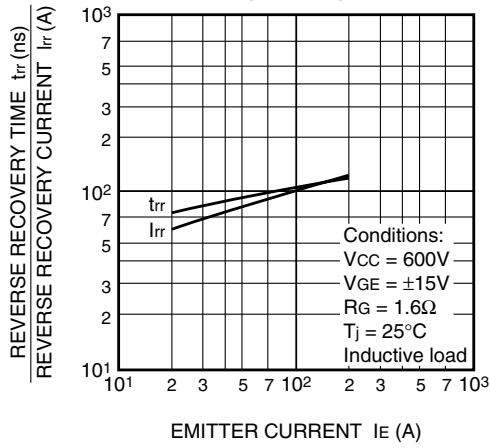
CAPACITANCE-VCE CHARACTERISTICS (TYPICAL)



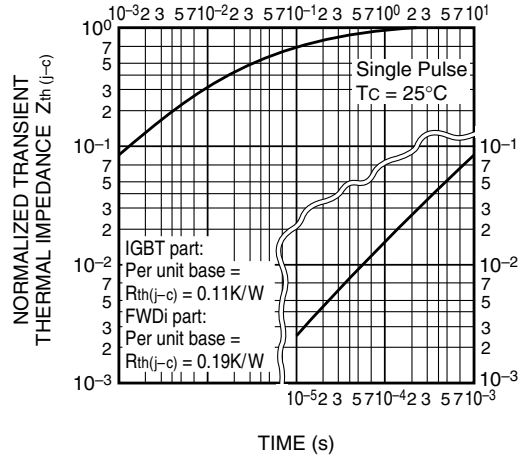
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)



REVERSE RECOVERY CHARACTERISTICS OF FREE-WHEEL DIODE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT part & FWDi part)



GATE CHARGE CHARACTERISTICS (TYPICAL)

